#### 503430095 08/10/2015

# PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT3476728

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

#### **CONVEYING PARTY DATA**

Name	Execution Date
MAKOTO SANO	05/07/2015
MITSUKUNI TSUKIHARA	05/08/2015
HARUKA SASAKI	05/06/2015
KOUJI INADA	05/06/2015

# **RECEIVING PARTY DATA**

Name:	SUMITOMO HEAVY INDUSTRIES ION TECHNOLOGY CO., LTD.	
Street Address:	1-1, OSAKI 2-CHOME, SHINAGAWA-KU	
City:	TOKYO	
State/Country:	JAPAN	
Postal Code:	141-6025	

#### **PROPERTY NUMBERS Total: 1**

Property Type	Number
Application Number:	14821507

## **CORRESPONDENCE DATA**

Fax Number: (202)955-3751

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent

using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Phone: 202-955-3750

Email: mtanaka@fishmanstewart.com

**Correspondent Name:** FISHMAN STEWART YAMAGUCHI PLLC Address Line 1: 1233 20TH STREET N.W., SUITE 501

Address Line 4: WASHINGTON, D.C. 20036

ATTORNEY DOCKET NUMBER:	PRI-0103
NAME OF SUBMITTER:	BRIAN K. DUTTON
SIGNATURE:	/Brian K. Dutton/
DATE SIGNED:	08/10/2015

**Total Attachments: 2** 

source=DC723632#page1.tif source=DC723632#page2.tif

> **PATENT** REEL: 036291 FRAME: 0825

503430095

Docket Number: PRI-0103

### ASSIGNMENT

WHEREAS, I, as a below named inventor, residing at the address stated next to my name, am a sole inventor (if only one name is listed below) or a joint inventor (if plural names are listed below) of certain new and useful improvements in

# ION IMPLANTER, ION IMPLANTATION METHOD, AND BEAM MEASUREMENT APPARATUS

for which application for Letters Patent of the United States of America was executed by me on the date indicated next to my name and address;

AND WHEREAS, Sumitomo Heavy Industries Ion Technology Co., Ltd., a Japanese corporation with offices at 1-1, Osaki 2-chome, Shinagawa-ku, Tokyo 141-6025, Japan, (hereinafter referenced as ASSIGNEES) is desirous of acquiring all interest in, to and under said invention, said application disclosing the invention and in, to and under any Letters Patent or similar legal protection which may be granted therefor in the United States and in any and all foreign countries;

NOW THEREFORE, in consideration of the sum of Ten Dollar (\$10.00), and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I, as a sole or joint inventor as indicated below, by these presents do hereby assign, sell and transfer unto the said ASSIGNEES, its successors, assigns, and legal representatives, the entire right, title and interest in the said invention, said application, including any divisions and continuations thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and to any other benefits accruing or to accrue to me with respect to the filing of applications for patents or securing of patents in the United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue the said United States Letters Patent to said ASSIGNEES, as the assignee of the whole right, title and interest thereto;

And I further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of ASSIGNEES or its designee, as ASSIGNEES or its successors, assigns and legal representatives may from time-to-time present to me and without further remuneration, in order to perfect title in said invention, modifications, and improvements in said invention, applications and Letters Patent of the United

PATENT REEL: 036291 FRAME: 0826

Docket Number: PRI-0103

States and countries foreign thereto;

And I further agree to properly execute and deliver and without further remuneration, such necessary or desirable and lawful papers for application for foreign patents, for filing subdivisions of said application for patent, and or, for obtaining any reissue or reissues of any Letters Patent which may be granted for my aforesaid invention, as the ASSIGNEE thereof shall hereafter require and prepare at its own expense;

And I further agree that ASSIGNEES will, upon its request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent and legal equivalents in foreign countries as may be known and accessible to me and will testify as to the same in any interference or litigation related thereto;

And I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale.

And I hereby authorize and request my attorney(s) of record in this application to insert the serial number and filing date of this application in the spaces that follow:

Serial Number: 14/821,507 , Filing Date: 08/07/2015

This assignment executed on the dates indicated below.

May / 07/20/3-Date Mitsukuni TSUKIHARA Signature May | 08 | 2015 Date May /06/20/5 Kouji inADA Signature

> **PATENT** REEL: 036291 FRAME: 0827

RECORDED: 08/10/2015